

International

IOR Rectifier

HEXFET® POWER MOSFET

Provisional Data Sheet No. PD-9.335E

JANTX2N6760

JANTXV2N6760

[REF:MIL-PRF-19500/542]

[GENERIC:IRF330]

N-CHANNEL

400 Volt, 1.00Ω HEXFET

HEXFET technology is the key to International Rectifier's advanced line of power MOSFET transistors. The efficient geometry achieves very low on-state resistance combined with high transconductance.

HEXFET transistors also feature all of the well-established advantages of MOSFETs, such as voltage control, very fast switching, ease of paralleling and electrical parameter temperature stability. They are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers, and high energy pulse circuits, and virtually any application where high reliability is required.

Product Summary

Part Number	BV _{DSS}	R _{DS(on)}	I _D
JANTX2N6760	400V	1.00Ω	5.5A
JANTXV2N6760			

Features:

- Avalanche Energy Rating
- Dynamic dv/dt Rating
- Simple Drive Requirements
- Ease of Paralleling
- Hermetically Sealed

Absolute Maximum Ratings

	Parameter	JANTX2N6760, JANTXV2N6760	Units
I _D @ V _{GS} = 10V, T _C = 25°C	Continuous Drain Current	5.5	A
I _D @ V _{GS} = 10V, T _C = 100°C	Continuous Drain Current	3.5	
I _{DM}	Pulsed Drain Current ①	22	
P _D @ T _C = 25°C	Max. Power Dissipation	75	W
	Linear Derating Factor	0.60	W/K ⑤
V _{GS}	Gate-to-Source Voltage	±20	V
E _{AS}	Single Pulse Avalanche Energy ②	1.7	mJ
I _{AR}	Avalanche Current ①	5.5	A
E _{AR}	Repetitive Avalanche Energy ①	—	mJ
dv/dt	Peak Diode Recovery dv/dt ③	4.0	V/ns
T _J	Operating Junction	-55 to 150	°C
T _{STG}	Storage Temperature Range		
	Lead Temperature	300 (0.063 in. (1.6mm) from case for 10.5 seconds)	
	Weight	11.5 (typical)	g

JANTX2N6760, JANTXV2N6760 Device

Electrical Characteristics @ $T_j = 25^\circ\text{C}$ (Unless Otherwise Specified)

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	400	—	—	V	$V_{GS} = 0V, I_D = 1.0\text{ mA}$
$\Delta BV_{DSS}/\Delta T_j$	Temperature Coefficient of Breakdown Voltage	—	0.46	—	$V/^\circ\text{C}$	Reference to 25°C , $I_D = 1.0\text{ mA}$
$R_{DS(on)}$	Static Drain-to-Source On-State Resistance	—	—	1.00	Ω	$V_{GS} = 10V, I_D = 3.5A$ ④
		—	—	1.22		$V_{GS} = 10V, I_D = 5.5A$
$V_{GS(th)}$	Gate Threshold Voltage	2.0	—	4.0	V	$V_{DS} = V_{GS}, I_D = 250\mu A$
g_{fs}	Forward Transconductance	2.9	—	—	S (④)	$V_{DS} > 15V, I_{DS} = 3.5A$ ④
I_{DSS}	Zero Gate Voltage Drain Current	—	—	25	μA	$V_{DS} = 0.8 \times \text{Max Rating}, V_{GS} = 0V$
		—	—	250		$V_{DS} = 0.8 \times \text{Max Rating}$ $V_{GS} = 0V, T_j = 125^\circ\text{C}$
I_{GSS}	Gate-to-Source Leakage Forward	—	—	100	nA	$V_{GS} = 20V$
I_{GSS}	Gate-to-Source Leakage Reverse	—	—	-100		$V_{GS} = -20V$
Q_g	Total Gate Charge	17	—	39	nC	$V_{GS} = 10V, I_D = 5.5A$ $V_{DS} = \text{Max. Rating} \times 0.5$ see figures 6 and 13
Q_{gs}	Gate-to-Source Charge	2.0	—	6.0		
Q_{gd}	Gate-to-Drain ("Miller") Charge	8.0	—	20		
$t_{d(on)}$	Turn-On Delay Time	—	—	30	ns	$V_{DD} = 200V, I_D = 5.5A,$ $R_G = 7.5\Omega, V_{GS} = 10V$ see figure 10
t_r	Rise Time	—	—	40		
$t_{d(off)}$	Turn-Off Delay Time	—	—	80		
t_f	Fall Time	—	—	35		
L_D	Internal Drain Inductance	—	5.0	—	nH	Measured from the drain lead, 6mm (0.25 in.) from package to center of die.
L_S	Internal Source Inductance	—	13.0	—		Measured from the source lead, 6mm (0.25 in.) from package to source bonding pad.
C_{iss}	Input Capacitance	—	620	—	pF	$V_{GS} = 0V, V_{DS} = 25V$ $f = 1.0\text{ MHz}$ see figure 5
C_{oss}	Output Capacitance	—	200	—		
C_{rss}	Reverse Transfer Capacitance	—	75	—		

Source-Drain Diode Ratings and Characteristics

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
I _S	Continuous Source Current (Body Diode)	—	—	5.5	A	Modified MOSFET symbol showing the integral reverse p-n junction rectifier. 
I _{SM}	Pulse Source Current (Body Diode) ①	—	—	22		
V _{SD}	Diode Forward Voltage	—	—	1.5	V	T _J = 25°C, I _S = 5.5A, V _{GS} = 0V ④
t _{rr}	Reverse Recovery Time	—	—	700	ns	T _J = 25°C, I _F = 5.5A, di/dt ≤ 100A/μs V _{DD} ≤ 50V ④
Q _{RR}	Reverse Recovery Charge	—	—	6.2	μC	
t _{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by L _S + L _D .				

Thermal Resistance

	Parameter	Min.	Typ.	Max.	Units	Test Conditions
R_{thJC}	Junction-to-Case	—	—	1.67	K/W	Typical socket mount
R_{thJA}	Junction-to-Ambient	—	—	30		

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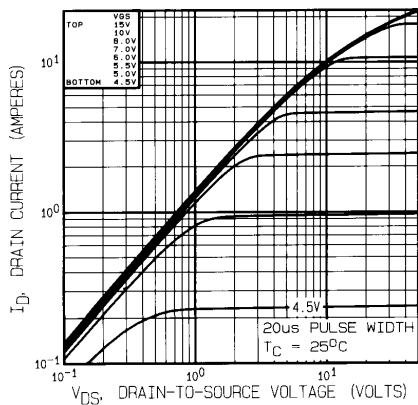


Fig. 1 — Typical Output Characteristics
 $T_C = 25^\circ\text{C}$

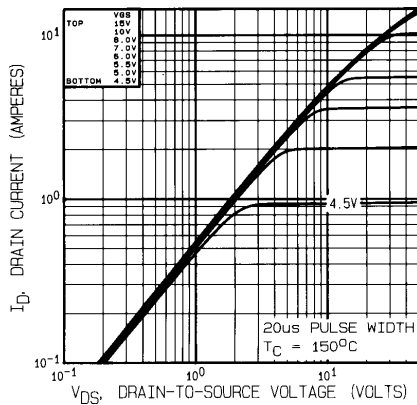


Fig. 2 — Typical Output Characteristics
 $T_C = 150^\circ\text{C}$

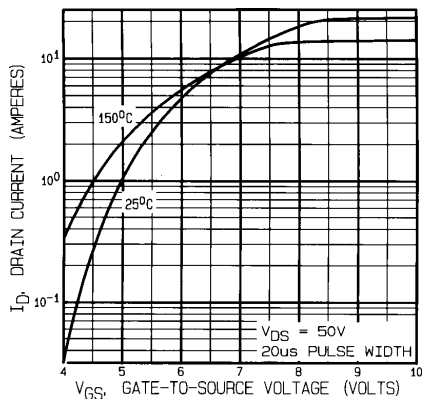


Fig. 3 — Typical Transfer Characteristics

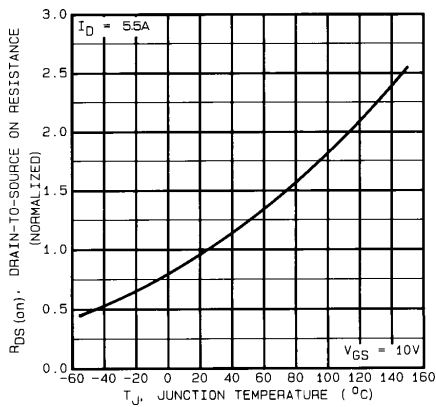


Fig. 4 — Normalized On-Resistance Vs. Temperature

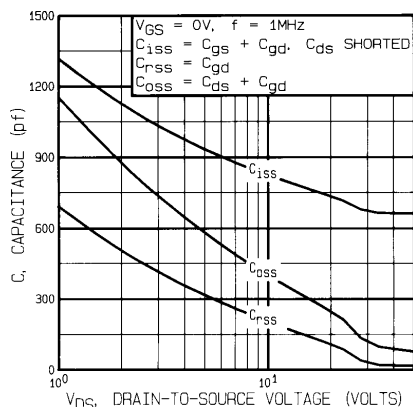


Fig. 5 — Typical Capacitance Vs. Drain-to-Source Voltage

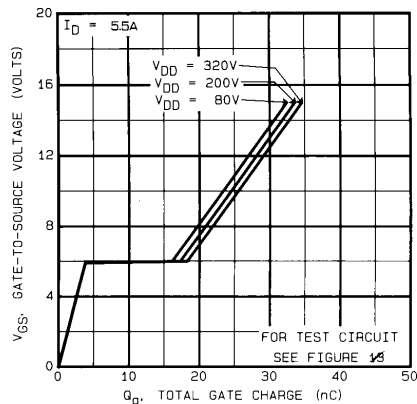


Fig. 6 — Typical Gate Charge Vs. Gate-to-Source Voltage

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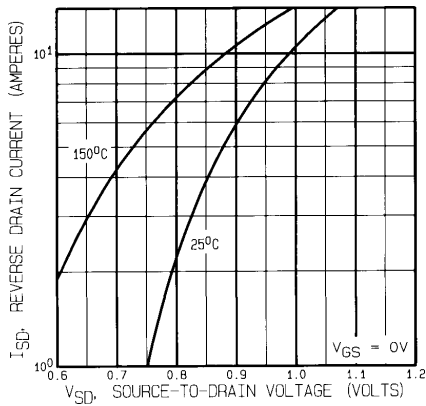


Fig. 7 — Typical Source-to-Drain Diode Forward Voltage

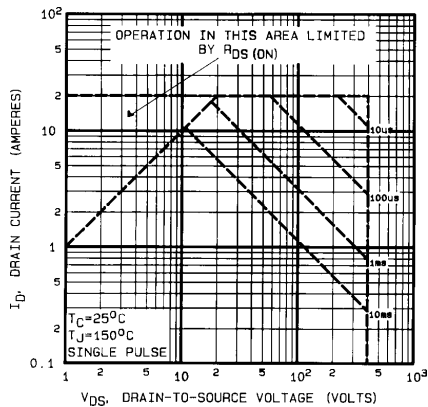


Fig. 8 — Maximum Safe Operating Area

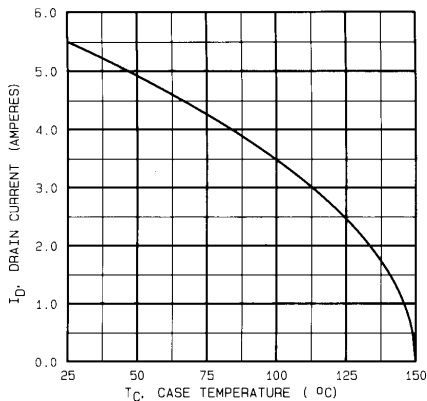


Fig. 9 — Maximum Drain Current Vs. Case Temperature

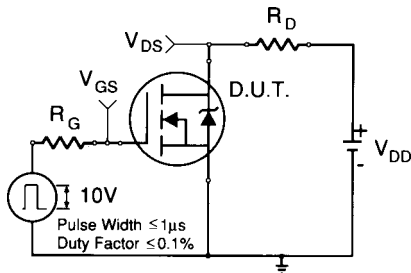


Fig. 10a — Switching Time Test Circuit

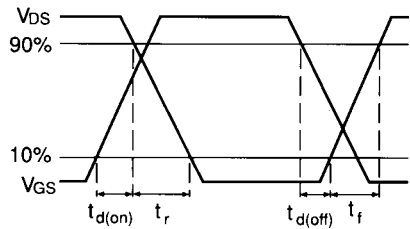


Fig. 10b — Switching Time Waveforms

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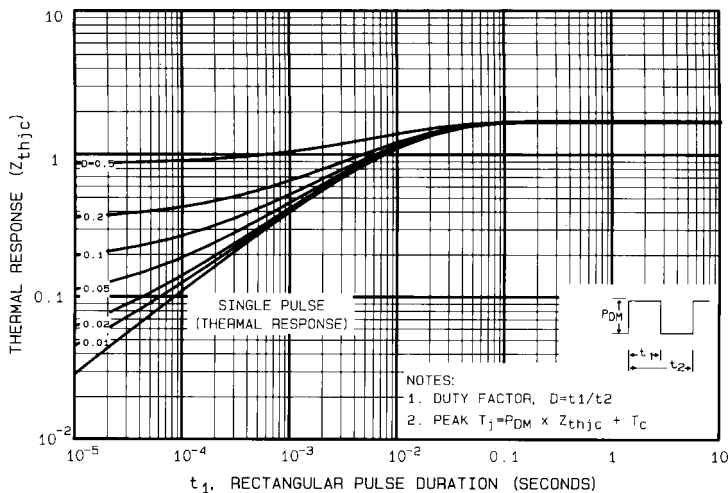


Fig. 11 — Maximum Effective Transient Thermal Impedance, Junction-to-Case Vs. Pulse Duration

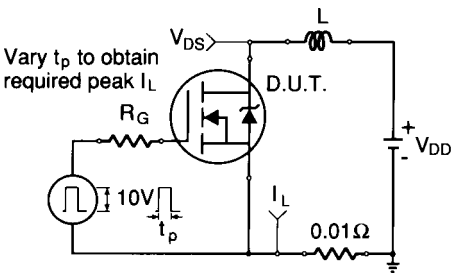


Fig. 12a — Unclamped Inductive Test Circuit

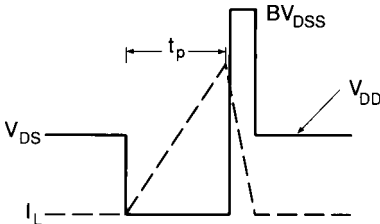


Fig. 12b — Unclamped Inductive Waveforms

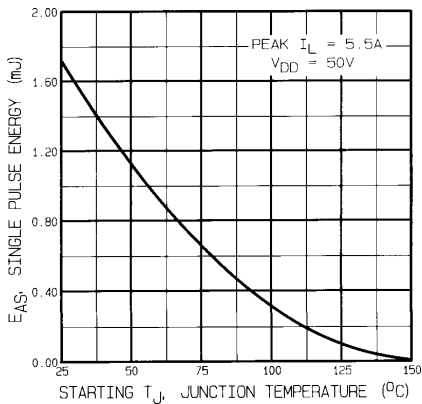


Fig. 12c — Max. Avalanche Energy vs. Current

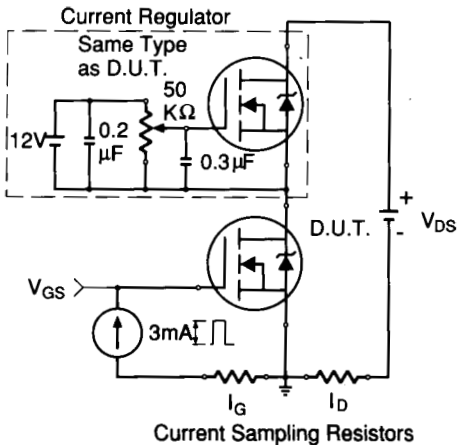


Fig. 13a — Gate Charge Test Circuit

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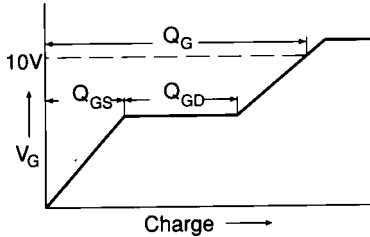
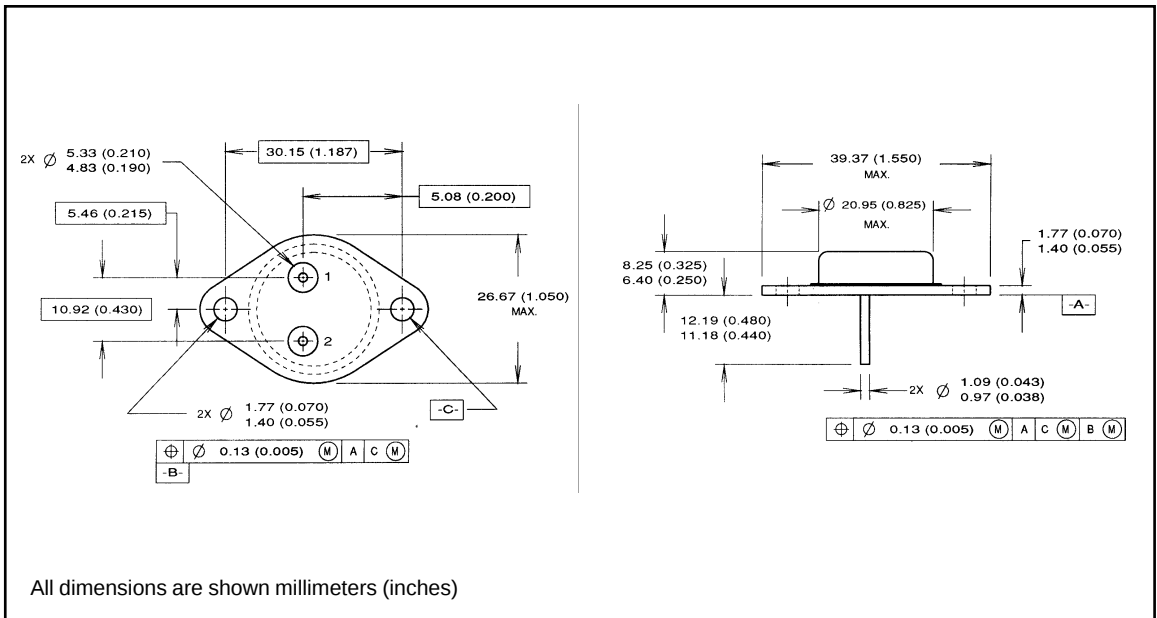


Fig. 13b — Basic Gate Charge Waveform

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
(see figure 11)
- ② @ $V_{DD} = 50V$, Starting $T_J = 25^{\circ}C$,
 $EAS = [0.5 * L * (I_L^2) * [BV_{DSS}/(BV_{DSS} - V_{DD})]]$
 Peak $I_L = 5.5A$, $V_{GS} = 10V$, $25 \leq R_G \leq 200\Omega$
- ③ $I_{SD} \leq 5.5A$, $di/dt \leq 90A/\mu s$,
 $V_{DD} \leq BV_{DSS}$, $T_J \leq 150^{\circ}C$
- ④ Pulse width $\leq 300 \mu s$; Duty Cycle $\leq 2\%$
- ⑤ $K/W = ^{\circ}C/W$
 $W/K = W/^{\circ}C$

Case Outline and Dimensions — TO-204AA (Modified TO-3)



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